关于本报告

“ ESG ”

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2021 12 31

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GSSB GRI

2016 “ ”

https://www.GigaDevice.com

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GRI

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MCU

NOR Flash NAND Flash MCU Arm MCU
MCU
SENSOR
DRAM
“ ”

NOR FLASH

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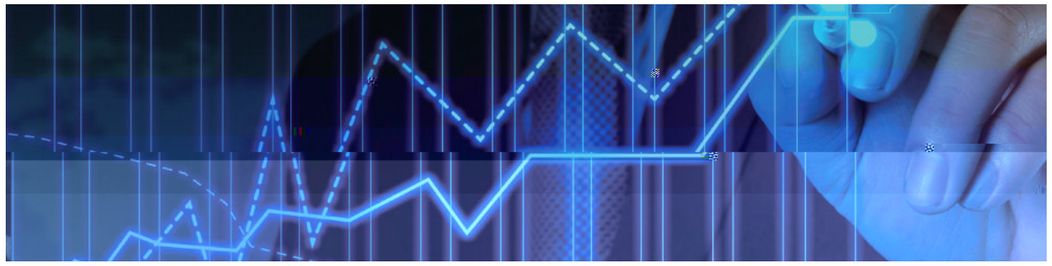
	-	
	IC	
GD T/LT	“ ”	
GD VF	RISC-V	ASPENCORE
GD LT		ASPENCORE
	IoT	
	“ ”	
GD E	/	ASPENCORE
	“ ”	
	MCU	
GD E x Cortex-M MCU		ASPENCORE
GD V MCU	IoT	
GD B/LB GE		ASPENCORE



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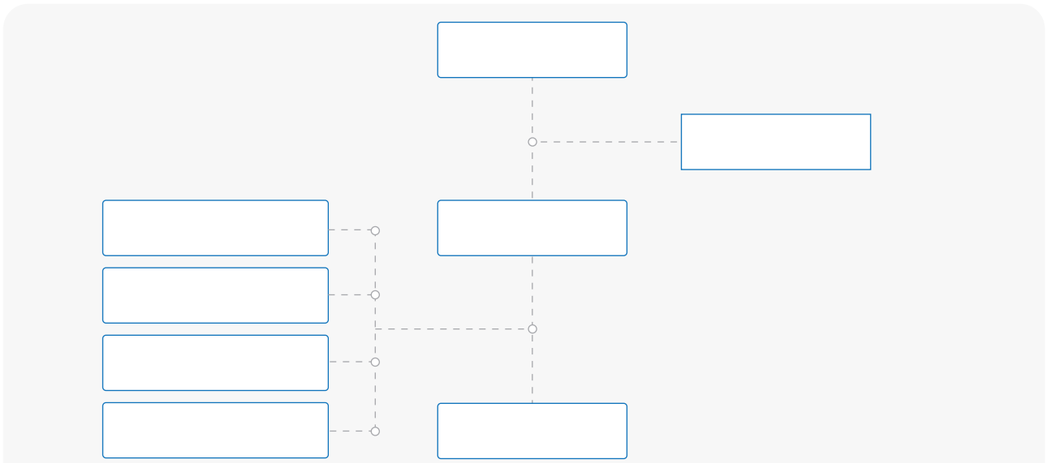

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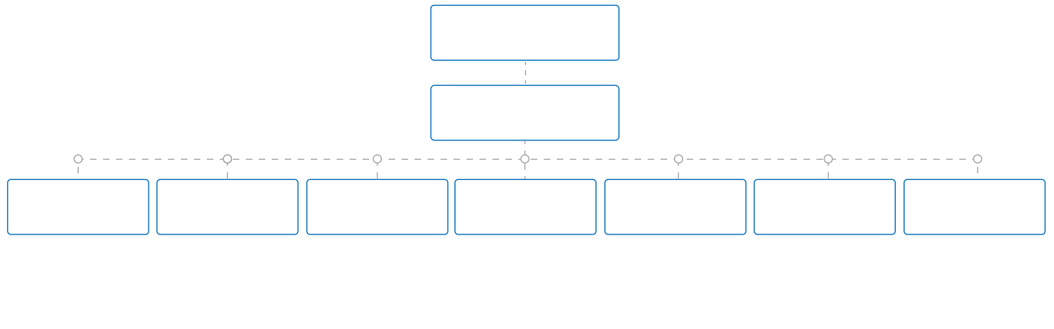
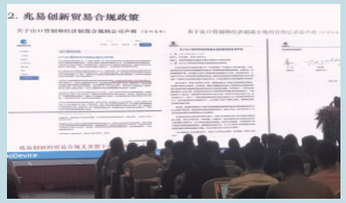
www.sse.com.cn -

IS GBT -



E-learning





ESG

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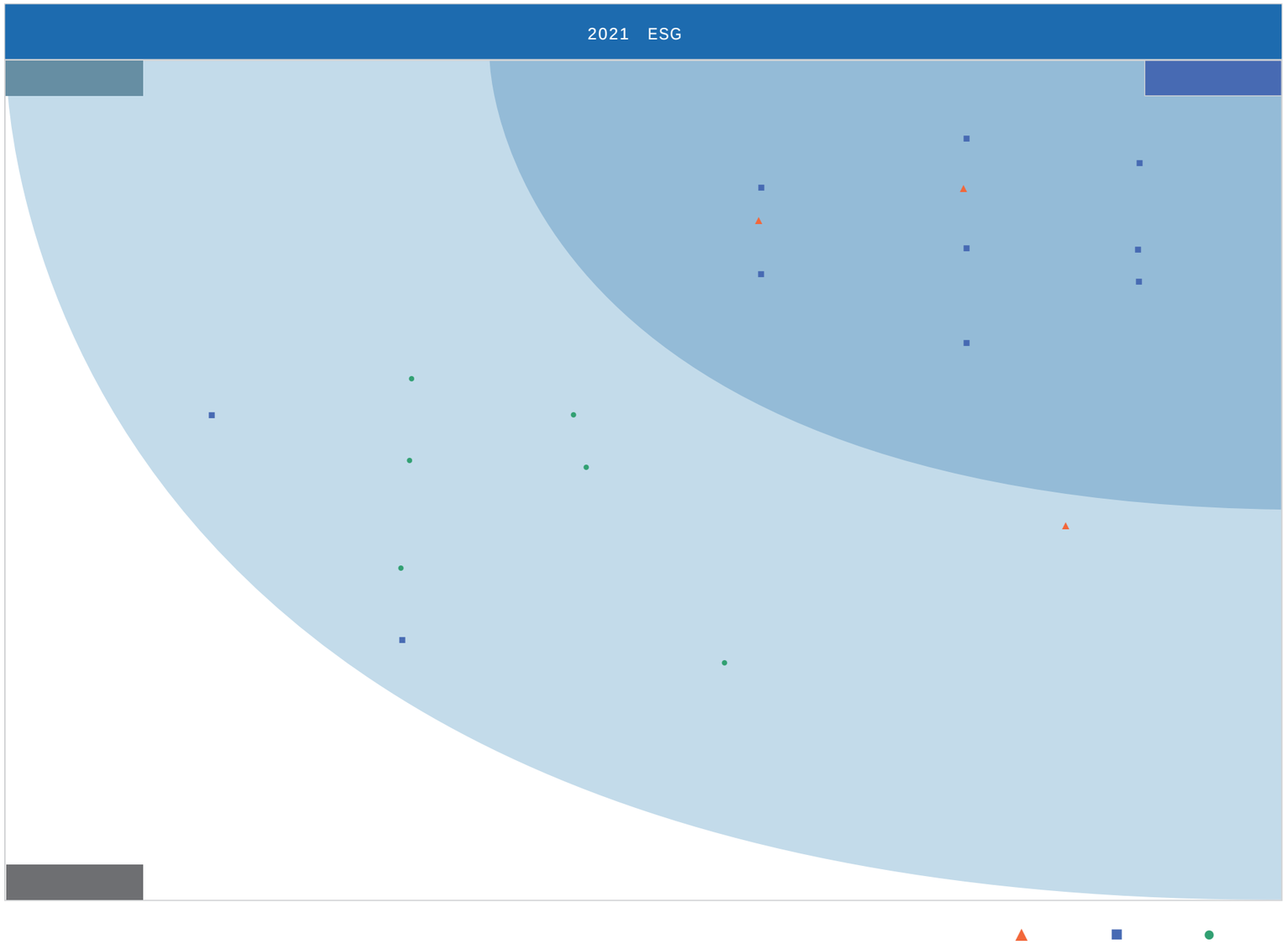

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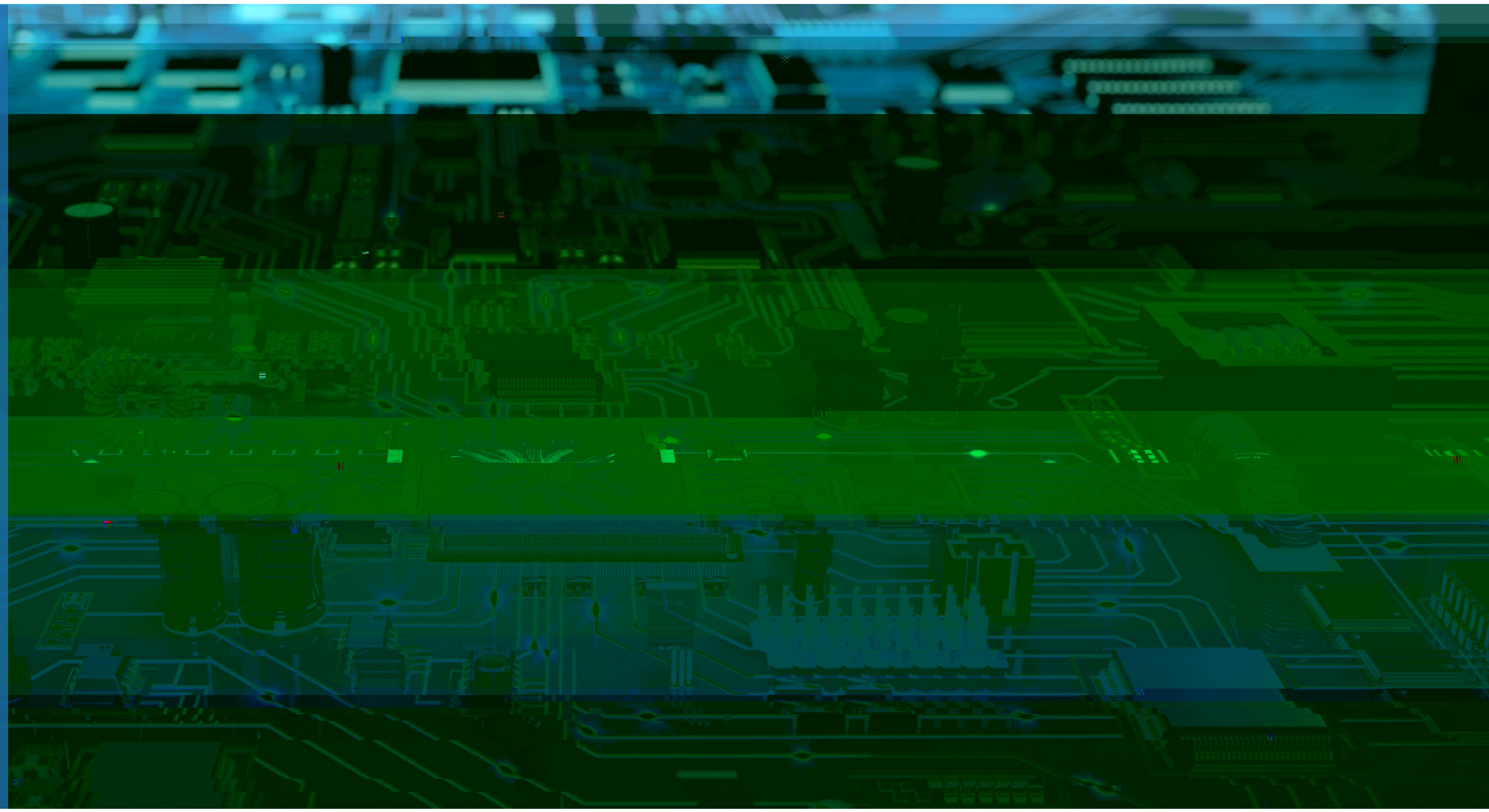

PC

GigaDevice –

NOR Flash Kb Gb

NAND Flash Gb- Gb

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PC

GD / GD F

MCU

AEC-Q SPI NOR

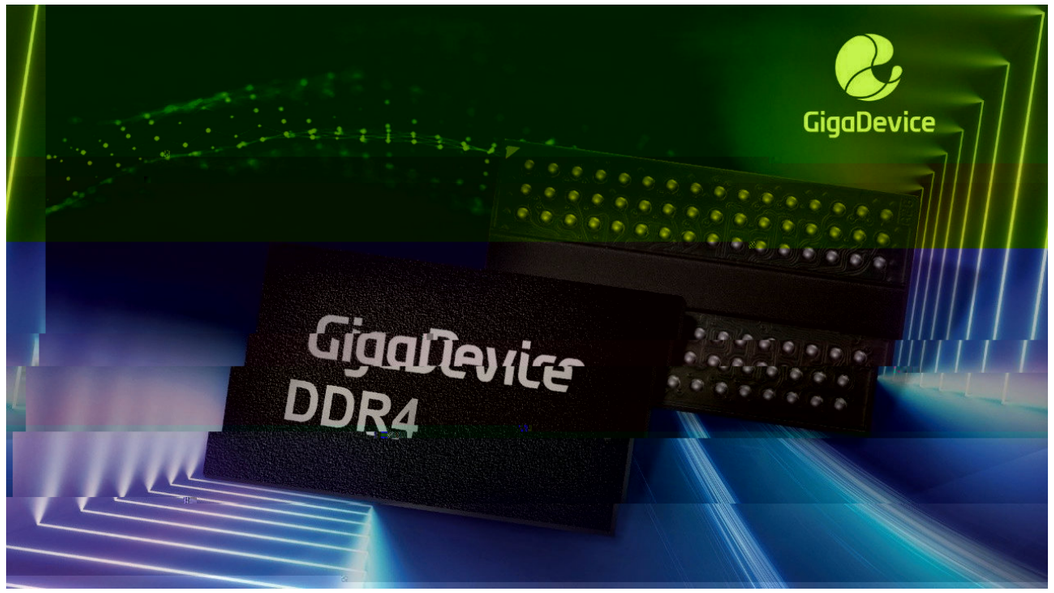
Flash SPI NAND Flash

DRAM

NOR Flash SLC NAND Flash DRAM

Gb DDR (nm

NOR Flash



Gb DDR GDQ BFAA

MCU

nm MCU

MCU IoT MCU

IoT MCU “ MCU ”

MCU



Cortex-M Wi-Fi MCU

LCD LCD

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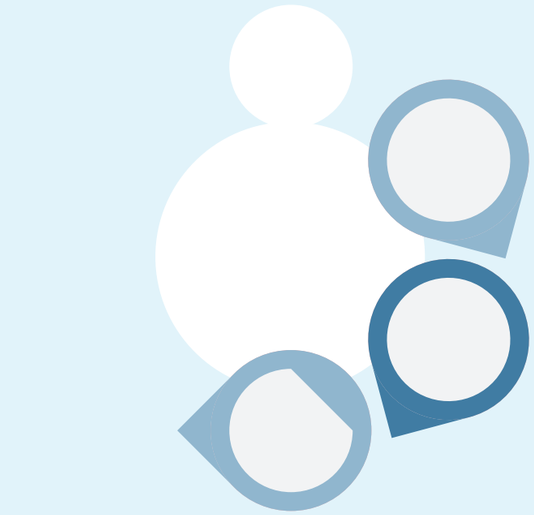

IPD Integrated Product Development

IPD

APQP





E-learning

E-Learning SQE CQE

RMA [1]

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RMA [2]

1.RMA =RMA ÷ =

2.Return Material Authorization

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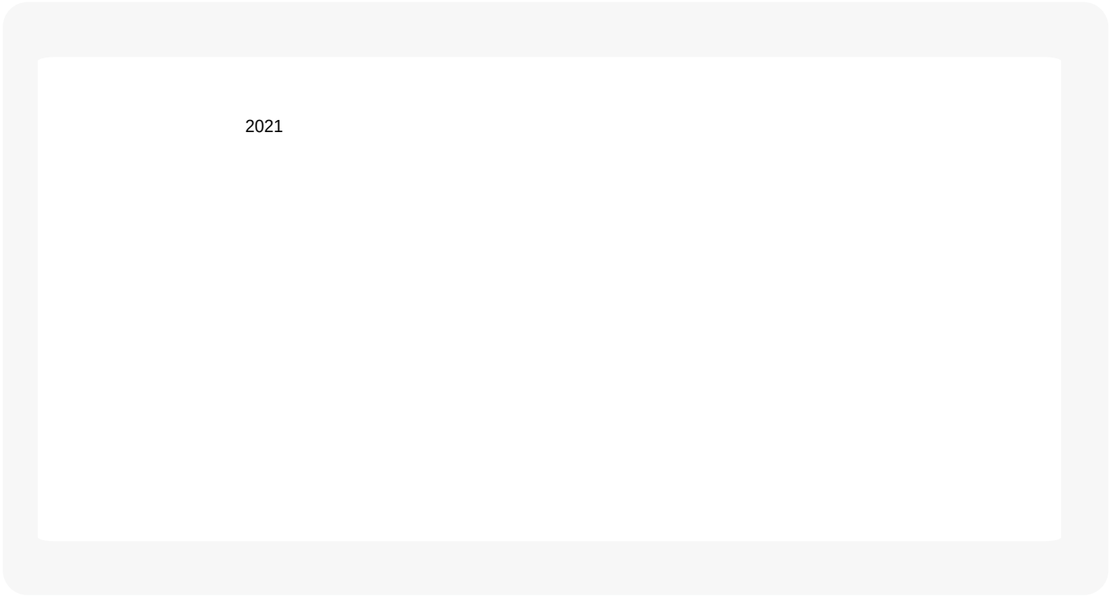
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E-learning

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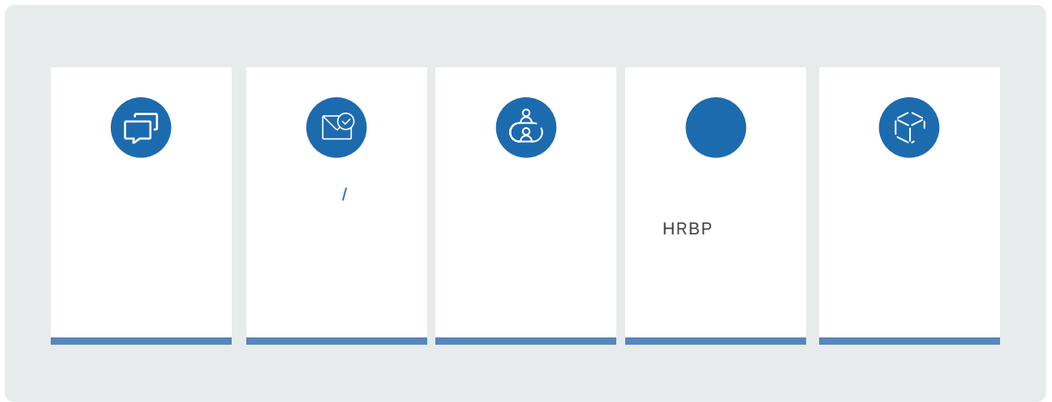
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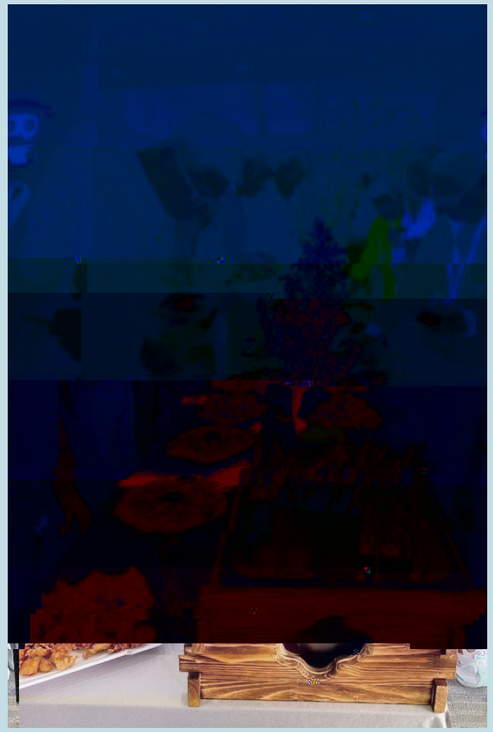





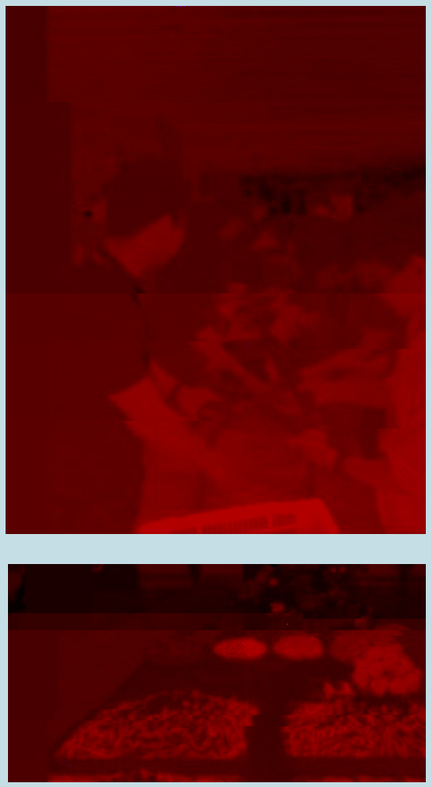



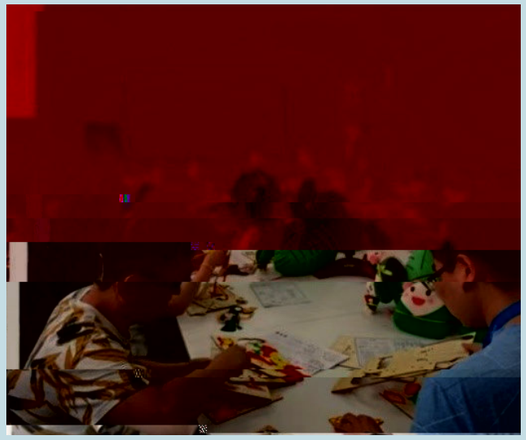



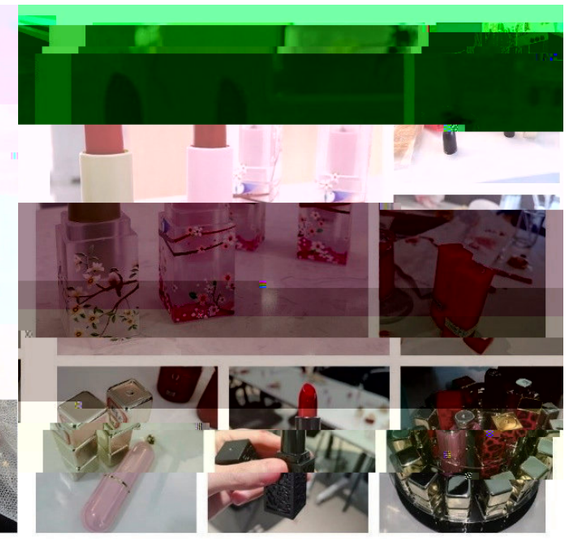

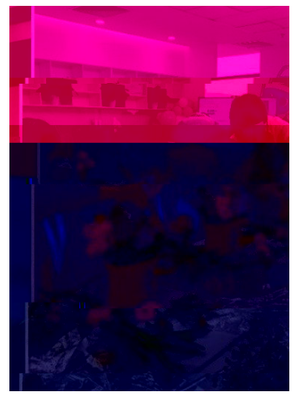

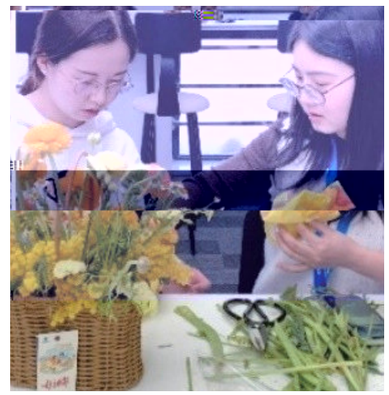

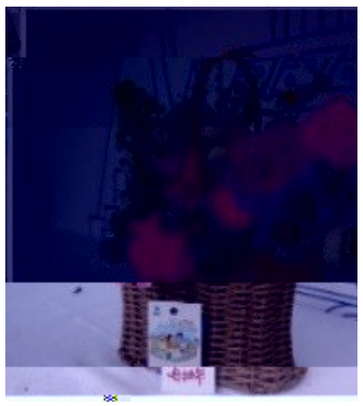

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CMRT[9] CRT[10] EMRT[11]

9.Conflict Minerals Reporting Template CMRT RMI

10.Cobalt Reporting Template,

11.Extended Minerals Reporting Template (EMRT)

12.Quarterly Business Review

7.Responsible Business Alliance " " 2017 10 17 EICC Electronic Industry Citizenship Coalition
RBA RBA 6.0

GigaDevice –

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MCU SEGGER IAR Systems

GD MCU Arm®MCU oneNET AWS Azure
Arm®Cortex®-M /M /M /M MCU GD MCU
RISC-V MCU Embedded World
RISC-V



* 以上为部分展示，更多GD32生态合作伙伴持续更新中
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GD

GD IDE
EVB RTOS GUI GD

/ b GDà p Azure E

MCU



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ELEXCON



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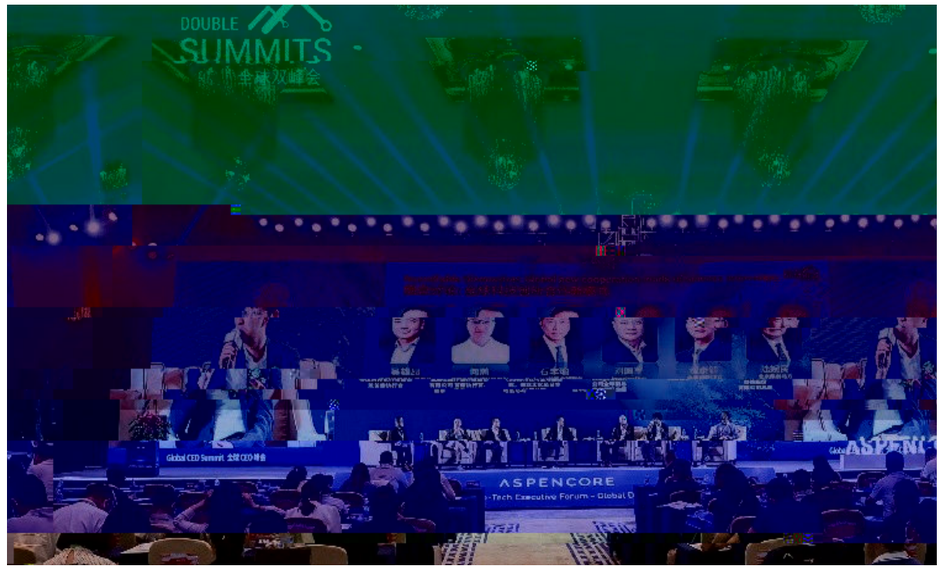

CEO “ ”



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GD MCU +Linkboy

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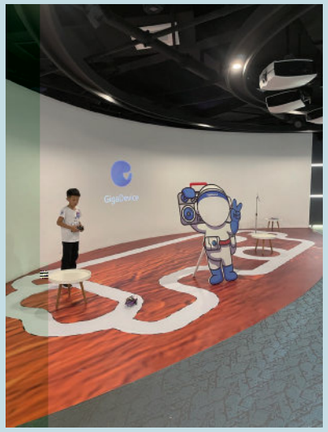

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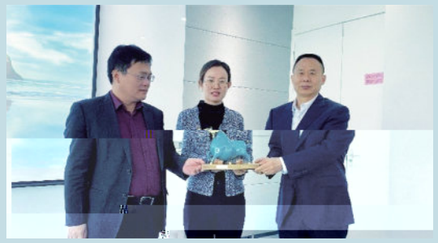

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